

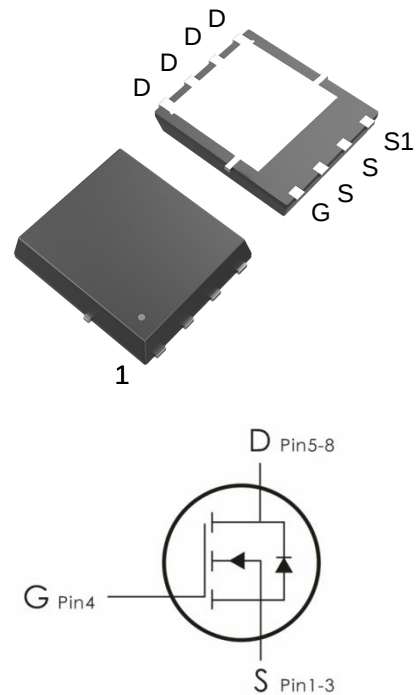
Description:

This N-Channel MOSFET uses advanced SGT technology and design to provide excellent $R_{DS(on)}$ with low gate charge.

It can be used in a wide variety of applications.

Features:

- 1) $V_{DS}=100V, I_D=100A, R_{DS(on)} < 4.3m\Omega @ V_{GS}=10V$ (Typ: $3.7m\Omega$)
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low $R_{DS(on)}$.
- 5) Excellent package for good heat dissipation.
- 6) MSL3



Package Marking and Ordering Information:

Part NO.	Marking	Package	Packing
DON100N10T	100N10T	DFN5*6-8	5000 pcs/Reel

Absolute Maximum Ratings: ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current- $T_C=25^\circ C$	100	A
	Continuous Drain Current- $T_C=100^\circ C$	70	
I_{DM}	Pulsed Drain Current ¹	400	
E_{AS}	Avalanche Energy, Single Pulse ²	230	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$
T_{LEAD}	Lead Temperature (Soldering, 10 sec)	260	$^\circ C$

Thermal Characteristics:

Symbol	Parameter	Max	Units
R_{thJC}	Thermal Resistance, Junction to Case	1.05	$^\circ C/W$
R_{thJA}	Thermal Resistance Junction to mbient	50	$^\circ C/W$

Electrical Characteristics: ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250 μ A	100	---	---	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} =0V, V _{DS} =100V	---	---	1	μ A
I _{GSS}	Gate-Source Leakage Current	V _{GS} =± 20V, V _{DS} =0A	---	---	± 100	nA
On Characteristics						
V _{GS(th)}	Gate-Source Threshold Voltage	V _{GS} =V _{DS} , I _D =250 μ A	2	3	4	V
R _{DS(ON)}	Drain-Source On Resistance ³	V _{GS} =10V, I _D =20A	---	3.7	4.3	m Ω
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, f=1MHz	---	3500	---	pF
C _{oss}	Output Capacitance		---	1000	--	
C _{rss}	Reverse Transfer Capacitance		---	20	---	
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DS} =50V, I _D =20A, R _{ENG} =3 Ω ,V _{GS} =10V	---	14	---	ns
t _r	Rise Time		---	7	---	ns
t _{d(off)}	Turn-Off Delay Time		---	32	---	ns
t _f	Fall Time		---	11	---	ns
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =50V, I _D =20A	---	57	---	nC
Q _{gs}	Gate-Source Charge		---	16	---	nC
Q _{gd}	Gate-Drain “Miller” Charge		---	11	---	nC
Drain-Source Diode Characteristics						
V _{SD}	Diode Forward Voltage	I _{SD} =20A	---	0.85	1	V
I _S	Continuous Drain Curren	V _D =V _G =0V	---	---	100	A
I _{SM}	Pulsed Drain Current		---	---	400	A
T _{rr}	Reverse Recovery Time	I _S =20A, T _J =25 °C	---	50	---	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/us	---	75	---	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition : $T_J=25^{\circ}\text{C}$, $V_{DD}=50\text{V}$, $V_G=10\text{V}$, $L=0.5\text{mH}$
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

Typical Characteristics: ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

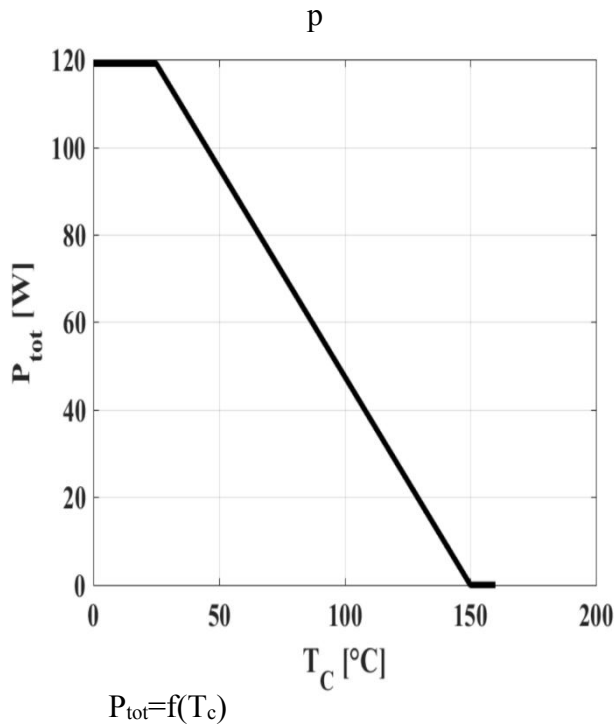


Figure 1 : Power Dissipation

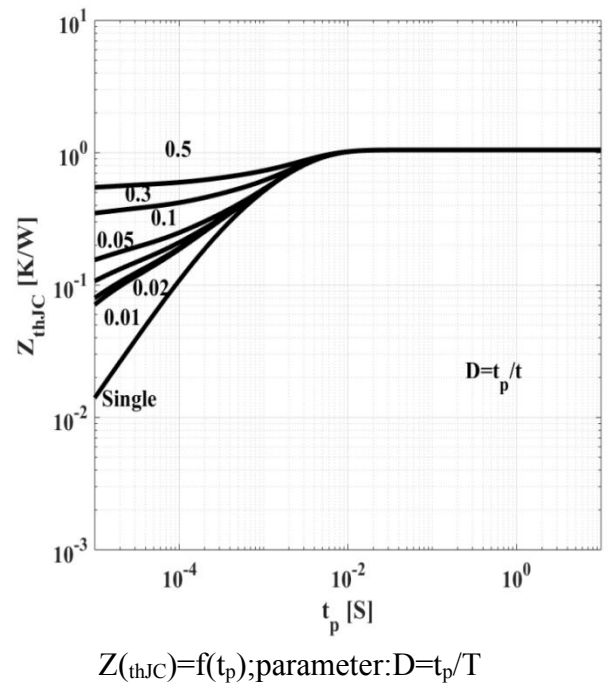


Figure 2 : Max. Transient Thermal Impedance

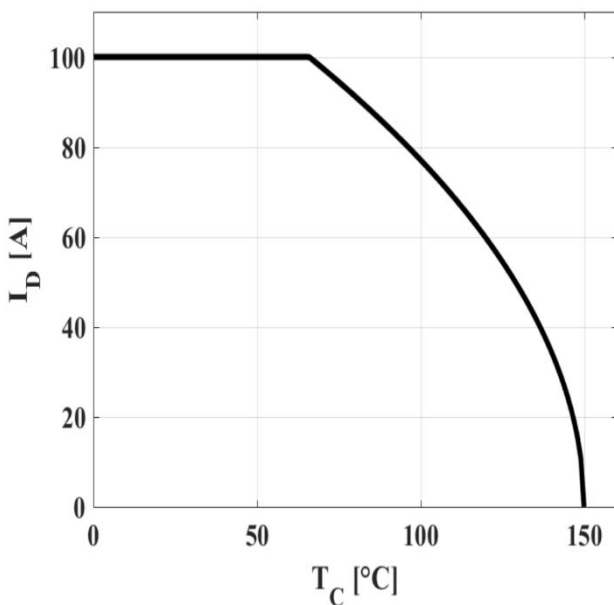


Figure3 : Drain Current

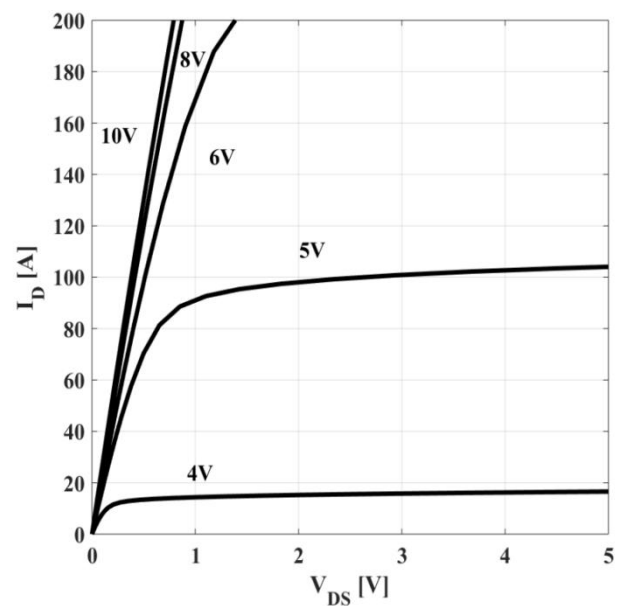
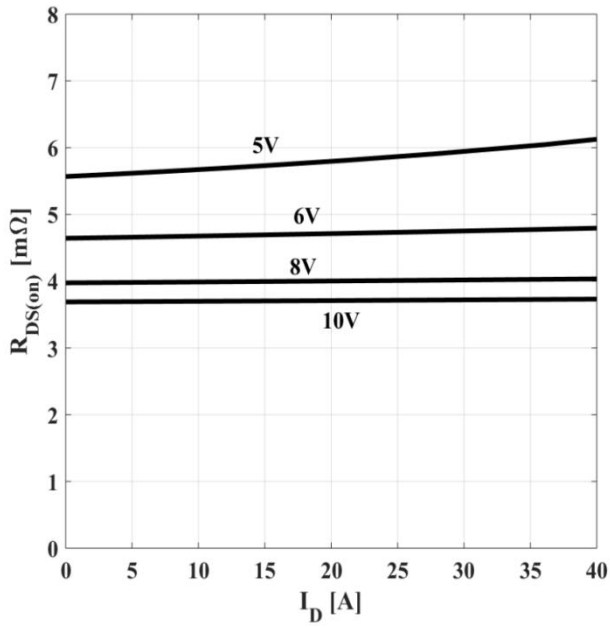
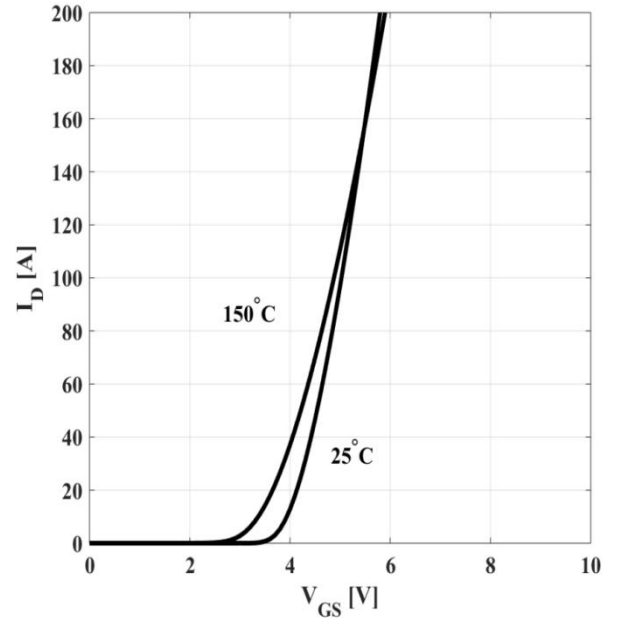


Figure4 : Typ. Output Characteristics



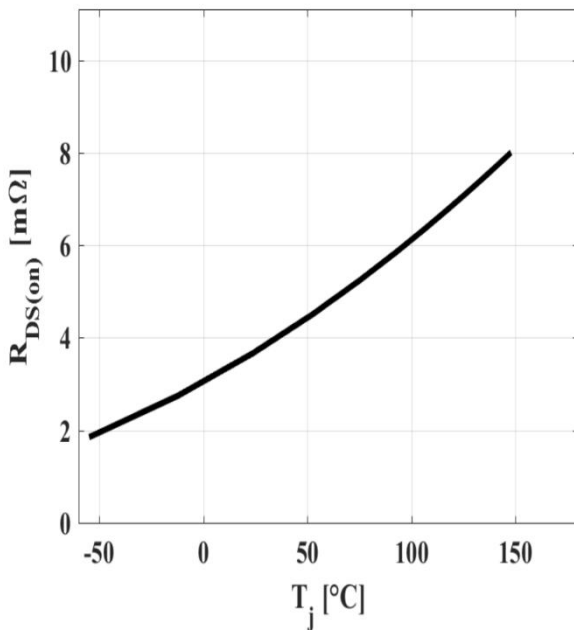
$$R_{DS(ON)}=f(I_D); T_j=25^{\circ}\text{C}; \text{ parameter: } V_{GS}$$

Figure5 : Typ. Drain-Source On-State Resistance



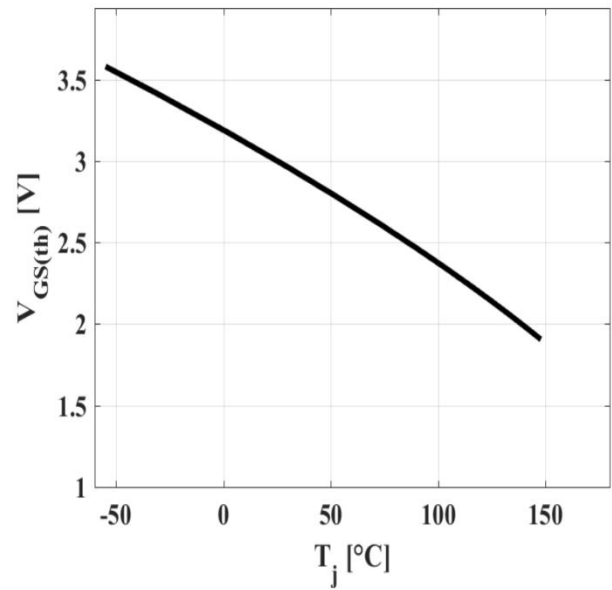
$$I_D=f(V_{GS}); |V_{DS}|>2|I_D|R_{DS(on)max}; \text{ parameter: } T_j$$

Figure6 : Typ. Transfer Characteristics



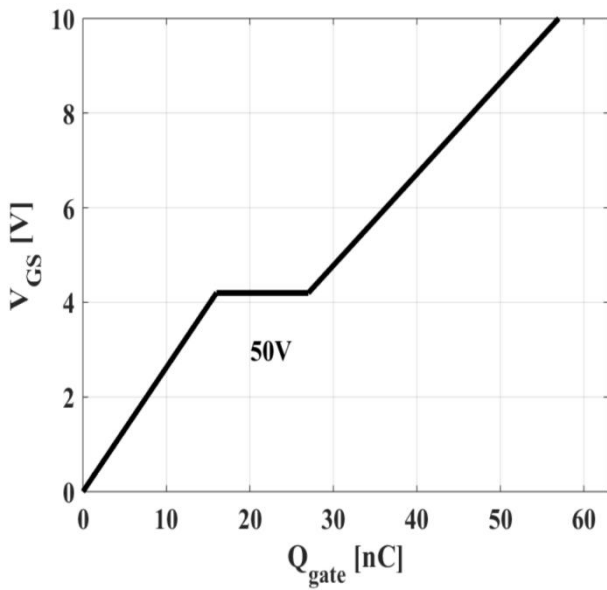
$$R_{DS(ON)}=f(T_j); I_D=20\text{A}; V_{GS}=10\text{V}$$

Figure7 : Typ. Drain-Source On-State Resistance(PDFN5*6)



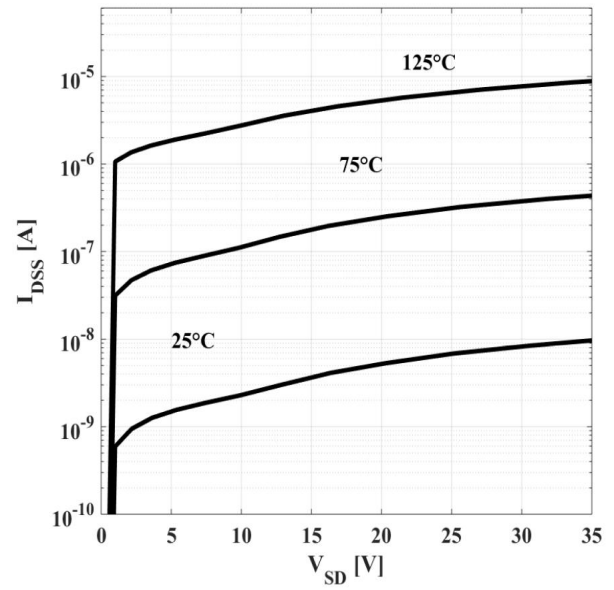
$$V_{GS(th)}=f(T_j); V_{GS}=V_{DS}; I_{DS}=250\mu\text{A}$$

Figure8 : Typ. Gate Threshold Voltage



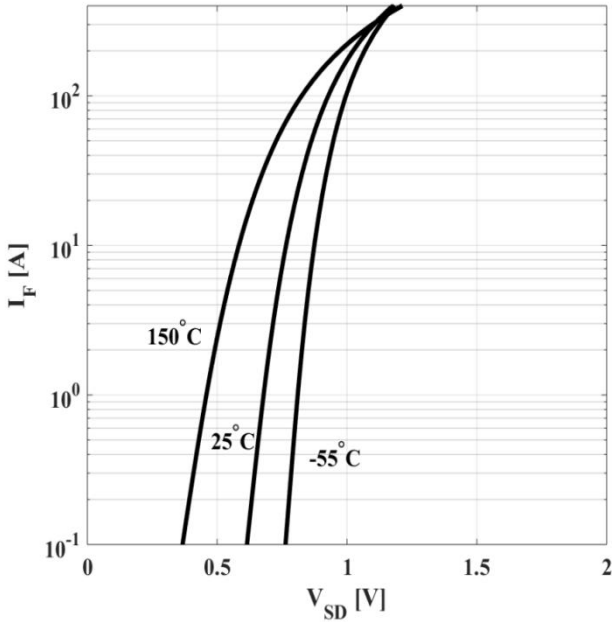
$$V_{GS} = f(Q_{gate}), I_D = 20A \text{ pulsed}$$

Figure 9 : Typ. Gate Charge



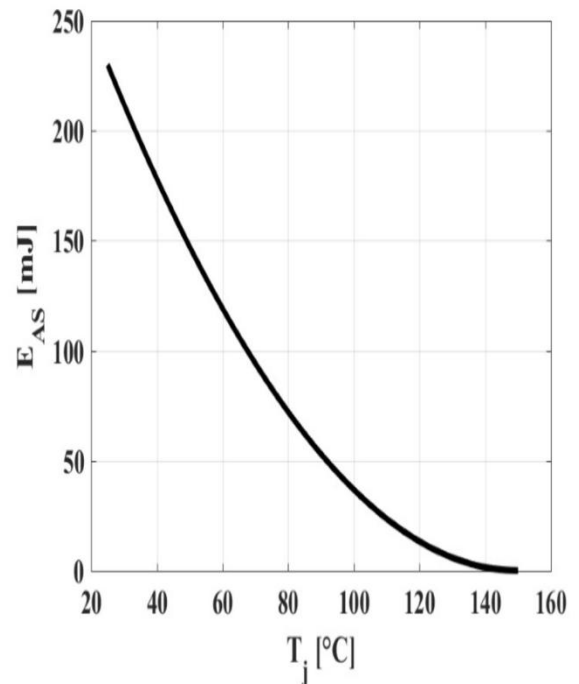
$$I_{DSS} = f(V_{DS}); V_{GS} = 0V; \text{ parameter: } T_j$$

Figure 10 : Drain-Source Leakage Current



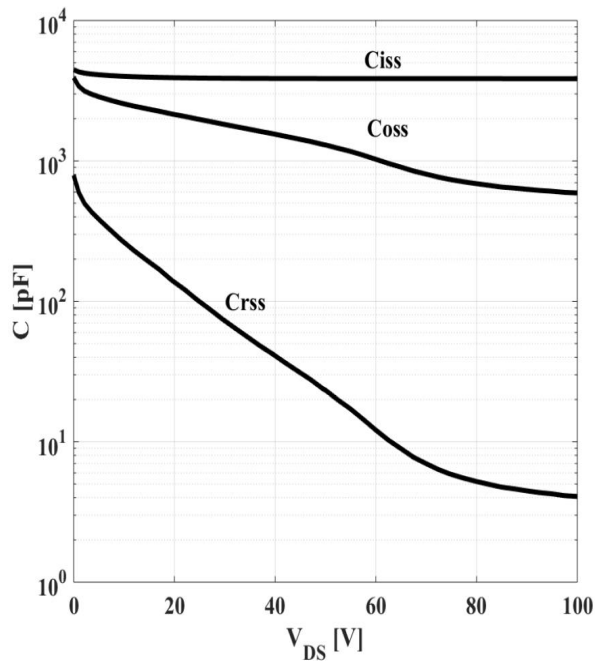
$$I_F = f(V_{SD}); \text{ parameter: } T_j$$

Figure 11: Forward Characteristics of Reverse Diode



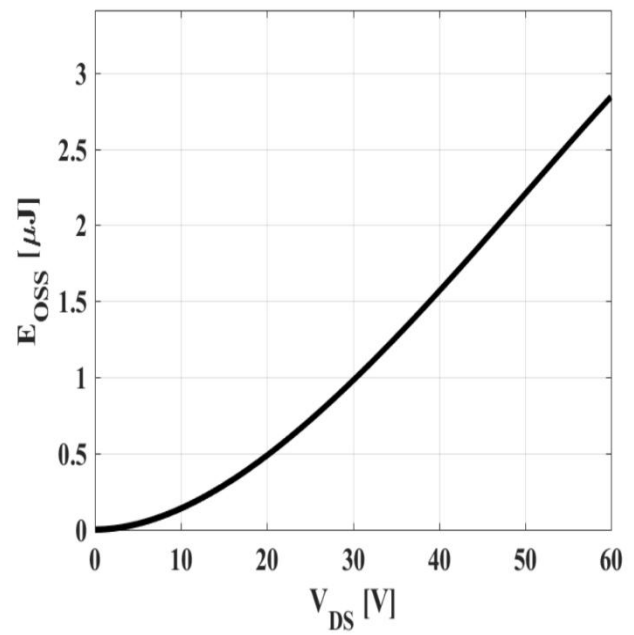
$$E_{AS} = f(T_j); I_D = 20.0A; V_{DD} = 20V$$

Figure 12: Avalanche Energy



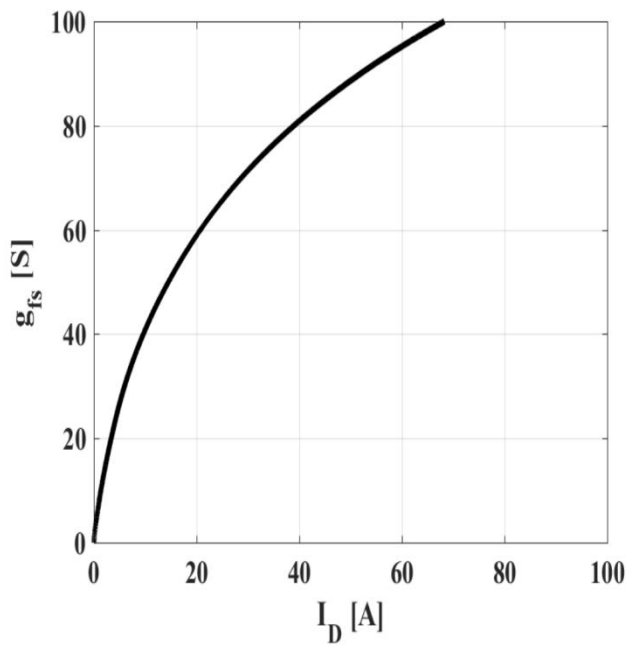
$$C=f(V_{DS}); V_{GS}=0; f=1\text{MHz}$$

Figure 13: Typ. Capacitances



$$E_{OSS}=f(V_{DS})$$

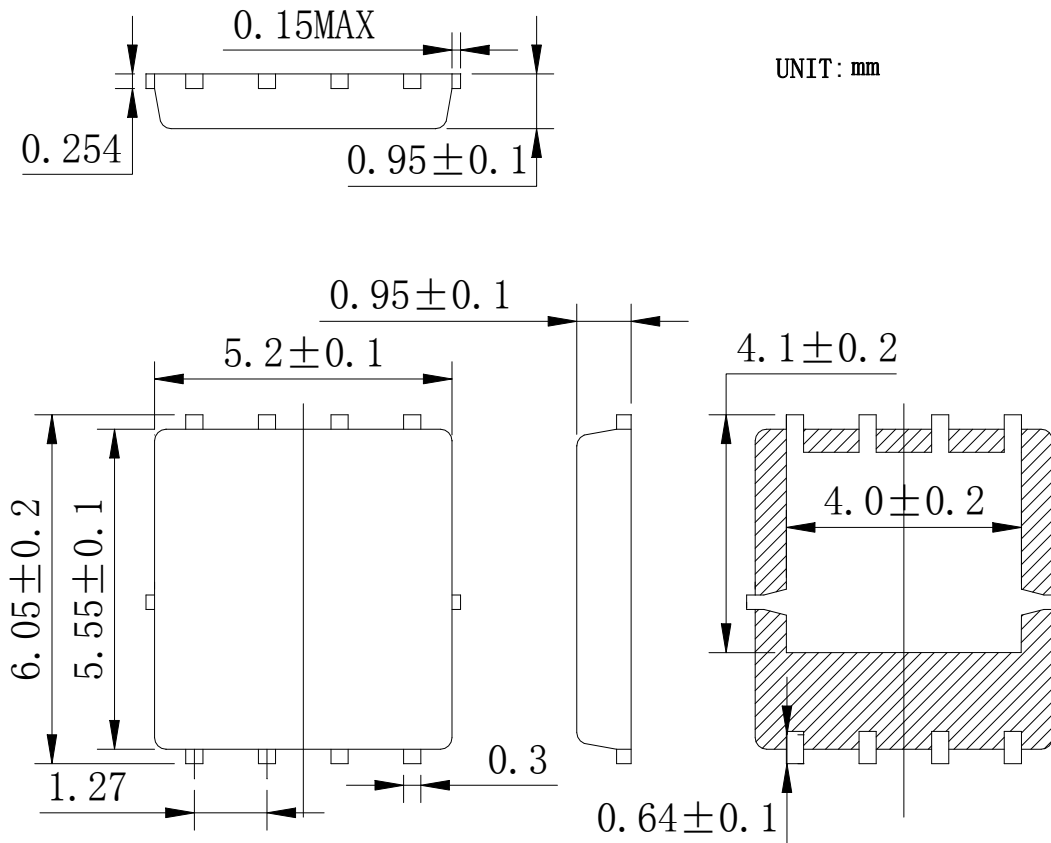
Figure 14: CossStored Energy



$$g_{fs}=f(I_D); T_j=25^{\circ}\text{C}$$

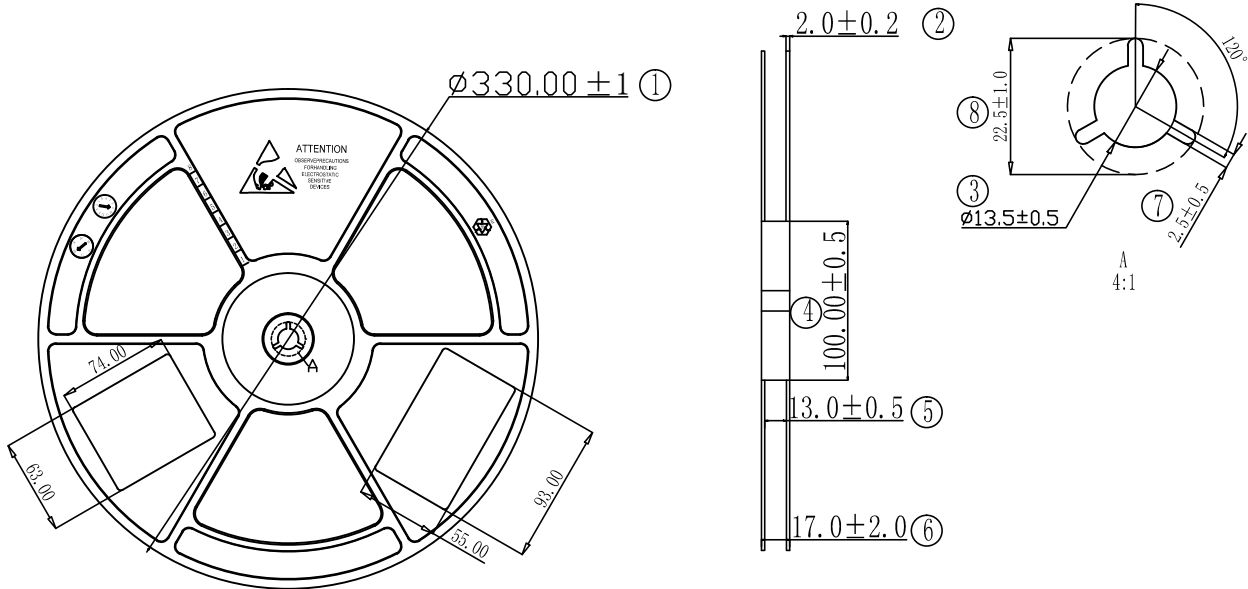
Figure15: Typ. Forward Transconductance

DFN5×6-8 Package Information:

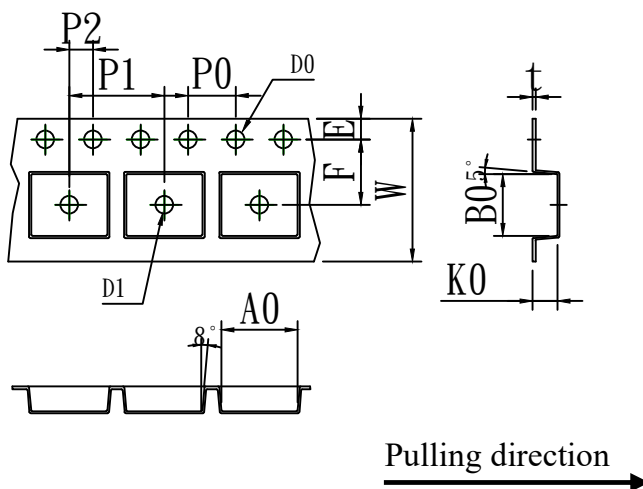


Tape & Reel Information

Dimensions in mm



Symbol	A0	B0	K0	D0	D1	P0	P1	10*P0
Spec	6.15±0.10	5.40±0.10	1.30±0.10	1.55±0.10	1.55±0.10	4.00±0.10	8.00±0.10	40.00±0.10
Symbol	W	E	F	P2	t			
Spec	12.00±0.10	1.75±0.10	5.50±0.10	2.00±0.10	0.20±0.05			



Marking Information:

①. Doingter LOGO

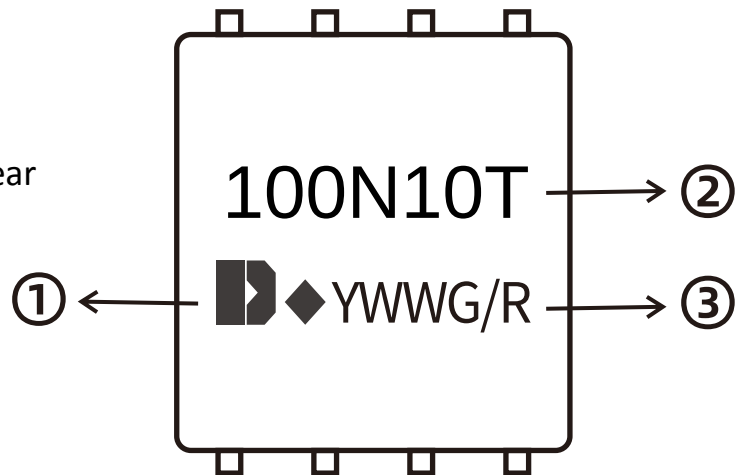
②. Part NO.

③. Date Code(YWWG / R)

Y : Year Code , last digit of the year

WW : Week Code(01-53)

G/R : G(Green) /R(Lead Free)

**Previous Version**

Version	Date	Subjects (major changes since last revision)
1.0	2023-05-06	Release of final version

Attention :

- Information furnished in this document is believed to be accurate and reliable. However, Shenzhen Doingter Semiconductor Co.,Ltd. assumes noresponsibility for the consequences of use without consideration for such information nor use beyond it.
 - Information mentioned in this document is subject to change without notice, apart from that when an agreement is signed, Shenzhen Doingter complies with the agreement. Products and information provided in this document have no infringement of patents.
 - Shenzhen Doingter assumes noresponsibility for any infringement of other rights of third parties which may result from the use of such products and information. This document supersedes and replaces all information previously supplied.
-  Is a registered trademark of Shenzhen Doingter Semiconductor Co., Ltd. Copyright © 2013 Shenzhen DoingterSemiconductor Co.,Ltd. Printed All rights reserved.